

TE Internal #: 2041021-3

TE Internal Description: Secure Digital Conn,top,Push-Pull,10 Au

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Connectors > PCB Connectors > Memory Card Connectors > SD Card Connectors



Compatible Card: Secure Digital

Number of Positions: 9

Centerline (Pitch): 1.7 mm, 2.43 mm, 2.5 mm [ .067 in, .095 in, .098 in ]

PCB Mounting Style: Surface Mount
PCB Mount Orientation: Right Angle

#### **Features**

### **Product Type Features**

Compatible Card	Secure Digital
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	9
PCB Mount Orientation	Right Angle
Contact Features	
Contact Current Rating (Max)	.5 A
Mechanical Attachment	
PCB Mounting Style	Surface Mount
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	1.7 mm, 2.43 mm, 2.5 mm[.067 in][.095 in][. 098 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
Circuit Application	Signal

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>



EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUL 2019 (201) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

# Customers Also Bought





TE Part #1-104652-0

100 50/50 GRID DRST SFMNT RCPT



2.0MM,HDR,13POS,VERTICAL



Z-PACK HS3 HDR ASY 10R 100P

TE Part #5120658-1





TE Part #216906-1 .250 POWER TERM.A.P











#### **Documents**

#### **CAD Files**

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2041021-3\_B\_c-2041021-3-b.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2041021-3\_B\_c-2041021-3-b.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2041021-3\_B\_c-2041021-3-b.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

#### Datasheets & Catalog Pages

SD Memory Card Connectors Quick Reference Guide (English)

English

#### **Product Specifications**

**Product Specification** 

English

**Product Specification** 

English

### **Product Environmental Compliance**

TE Material Declaration

English